S1A/B - S1M/B

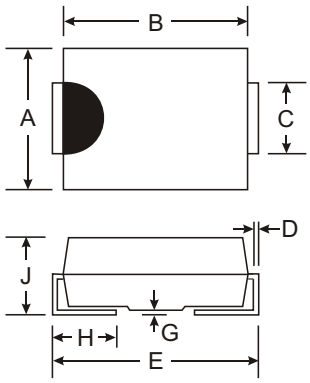
1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop and High Current Capability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly

Mechanical Data

- Case: Molded Plastic
- Case Material - UL Flammability Rating Classification 94V-0
- Moisture sensitivity: Level 1 per J-STD-020A
- Terminals: Solder Plated Terminal - Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- SMA Weight: 0.064 grams (approx.)
- SMB Weight: 0.093 grams (approx.)
- Marking: Type Number, See Page 2
- Ordering Information: See Page 2



	SMA		SMB	
Dim	**Min**	**Max**	**Min**	**Max**
A	2.29	2.92	3.30	3.94
B	4.00	4.60	4.06	4.57
C	1.27	1.63	1.96	2.21
D	0.15	0.31	0.15	0.31
E	4.80	5.59	5.00	5.59
G	0.10	0.20	0.10	0.20
H	0.76	1.52	0.76	1.52
J	2.01	2.62	2.00	2.62
All Dimensions in mm				

A, B, D, G, J, K, M Suffix Designates SMA Package
AB, BB, DB, GB, JB, KB, MB Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	S1 A/AB	S1 B/BB	S1 D/DB	S1 G/GB	S1 J/JB	S1 K/KB	S1 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T_T = 100°C	I_O	1.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	30							A
Forward Voltage @ I_F = 1.0A	V_{FM}	1.1							V
Peak Reverse Leakage Current @ T_A = 25°C at Rated DC Blocking Voltage @ T_A = 125°C	I_{RM}	5.0 100							μA
Typical Total Capacitance (Note 1)	C_T	10							pF
Typical Thermal Resistance, Junction to Terminal (Note 2)	$R_{\theta JT}$	30							°C/W
Operating and Storage Temperature Range	T_j, T_{STG}	-65 to +150							°C

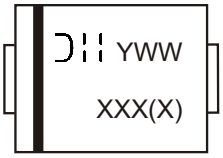
Notes: 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
2. Thermal Resistance Junction to Terminal, unit mounted on PC board with 5.0 mm^2 (0.013 mm thick) copper pads as heat sink.

Ordering Information (Note 3)

Device*	Packaging	Shipping
S1x-7 S1xB-7	SMA SMB	5000/Tape & Reel 3000/Tape & Reel

Notes: 3. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.
* x = Device type, e.g. S1A-7 (SMA package); S1AB-7 (SMB package).

Marking Information



XXX = Product type marking code, ex: S1A (SMA package)
XXXX = Product type marking code, ex: S1AB (SMB package)
= Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year ex: 2 for 2002
WW = Week code 01 to 52

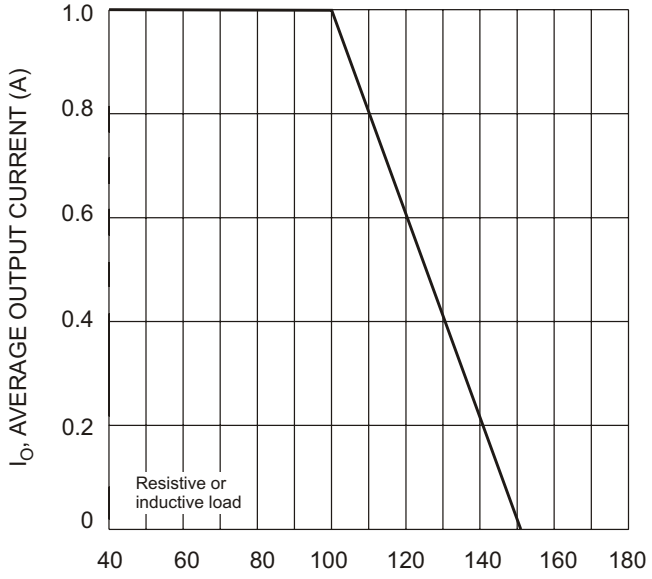


Fig. 1 Forward Current Derating Curve

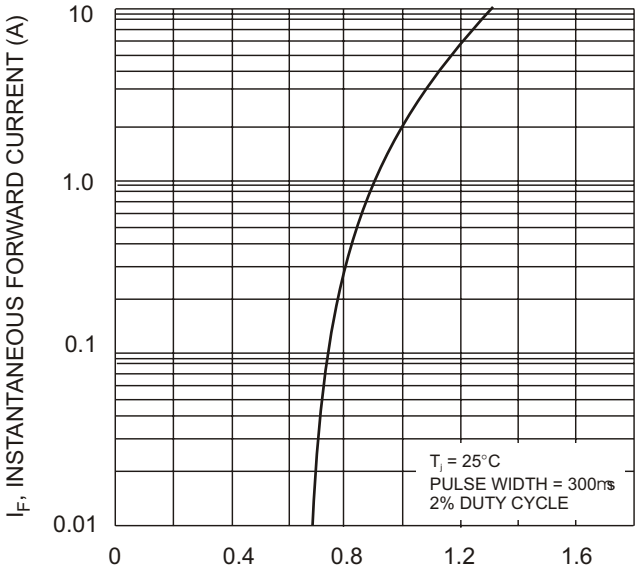


Fig. 2 Typical Forward Characteristics

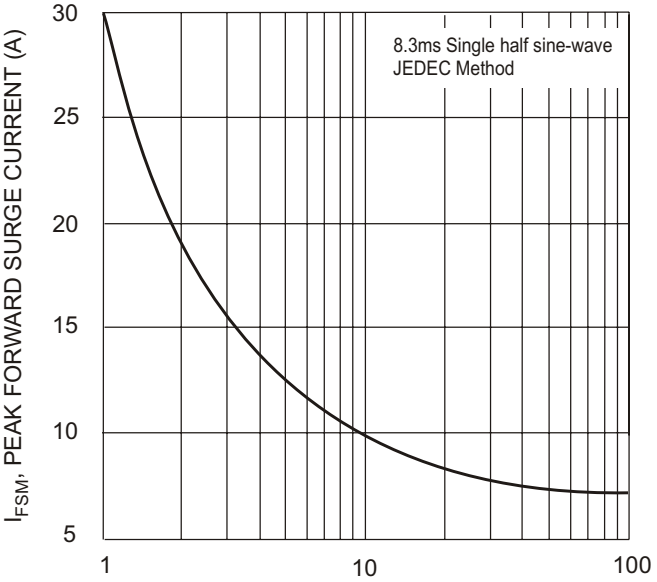


Fig. 3 Typical Forward Characteristics

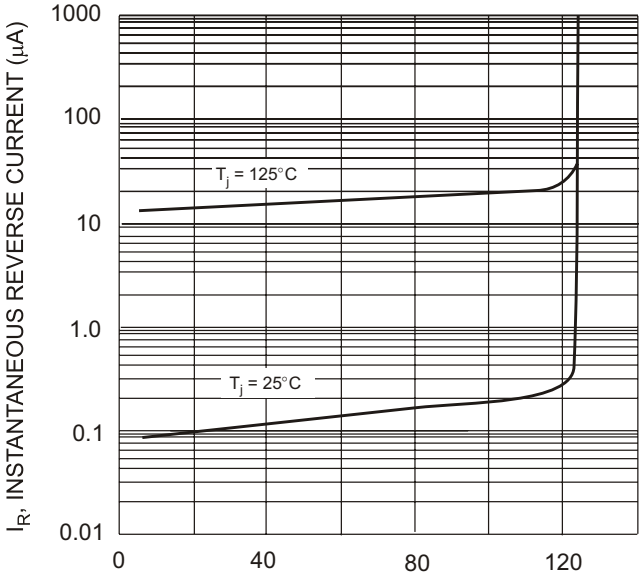


Fig. 4 Typical Reverse Characteristics